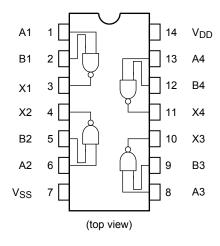
TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC4011BP, TC4011BF, TC4011BFT

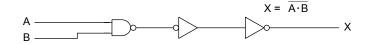
TC4011B Quad 2 Input NAND Gate

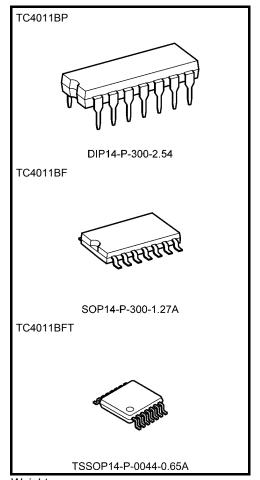
The TC4011B is 2-input positive logic NAND gate respectively. Since all the outputs of these gates are provided with the inverters as buffers, the input/output characteristics have been improved and the variation of propagation delay time due to the increase in load capacity is kept down to the minimum.

Pin Assignment



Logic Diagram





Weight

DIP14-P-300-2.54 : 0.96 g (typ.) SOP14-P-300-1.27A : 0.18 g (typ.) TSSOP14-P-0044-0.65A : 0.06 g (typ.)



Absolute Maximum Ratings (Note)

Characteristics	Symbol	Rating	Unit
DC supply voltage	V_{DD}	V _{SS} - 0.5 to V _{SS} + 20	V
Input voltage	V _{IN}	V _{SS} - 0.5 to V _{DD} + 0.5	V
Output voltage	V _{OUT}	V _{SS} - 0.5 to V _{DD} + 0.5	V
DC input current	I _{IN}	±10	mA
Power dissipation	PD	300 (DIP)/180 (SOP)	mW
Operating temperature range	T _{opr}	−40 to 85	°C
Storage temperature range	T _{stg}	−65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Operating Ranges (V_{SS} = 0 V) (Note)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
DC supply voltage	V_{DD}	_	3	_	18	V
Input voltage	V _{IN}	I	0	_	V_{DD}	V

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V_{DD} or V_{SS} .



Static Electrical Characteristics ($V_{SS} = 0 V$)

Characteristics			Test Condition		-40°C		25°C			85°C		
		Symbol		V _{DD} (V)	Min	Max	Min	Тур.	Max	Min	Max	Unit
High-lev output v		V _{OH}	I _{OUT} < 1 μA V _{IN} = V _{SS} , V _{DD}	5 10 15	4.95 9.95 14.95	_ _ _	4.95 9.95 14.95	5.00 10.00 15.00	_ _ _	4.95 9.95 14.95	_ _ _	V
Low-leve output v		V _{OL}	I _{OUT} < 1 μA V _{IN} = V _{SS} , V _{DD}	5 10 15	_ _ _	0.05 0.05 0.05	_ _ _	0.00 0.00 0.00	0.05 0.05 0.05	_ _ _	0.05 0.05 0.05	V
Output h	nigh	Юн	V _{OH} = 4.6 V V _{OH} = 2.5 V V _{OH} = 9.5 V V _{OH} = 13.5 V V _{IN} = V _{SS} , V _{DD}	5 5 10 15	-0.61 -2.50 -1.50 -4.00	- - -	-0.51 -2.10 -1.30 -3.40	-1.0 -4.0 -2.2 -9.0	- - -	-0.42 -1.70 -1.10 -2.80	- - -	mA
Output lo	ow	l _{OL}	$V_{OL} = 0.4 \text{ V}$ $V_{OL} = 0.5 \text{ V}$ $V_{OL} = 1.5 \text{ V}$ $V_{IN} = V_{DD}$	5 10 15	0.61 1.50 4.00		0.51 1.30 3.40	1.2 3.2 12.0		0.42 1.10 2.80		mA
Input hig voltage	gh	V _{IH}	V _{OUT} = 0.5 V V _{OUT} = 1.0 V V _{OUT} = 1.5 V OUT < 1 µA	5 10 15	3.5 7.0 11.0	_ _ _	3.5 7.0 11.0	2.75 5.50 8.25	_ _ _	3.5 7.0 11.0	_ _ _	٧
Input lov voltage	N	V _{IL}	V _{OUT} = 4.5 V V _{OUT} = 9.0 V V _{OUT} = 13.5 V OUT < 1 µA	5 10 15		1.5 3.0 4.0	_ _ _	2.25 4.50 6.75	1.5 3.0 4.0	_ _ _	1.5 3.0 4.0	٧
Input	"H" level	Iн	V _{IH} = 18 V	18	-	0.1	_	10 ⁻⁵	0.1	_	1.0	μА
current	"L" level	I _{IL}	V _{IL} = 0 V	18	ı	-0.1	_	-10 ⁻⁵	-0.1	_	-1.0	
Quiesce supply c		I _{DD}	V _{IN} = V _{SS} , V _{DD} (Note)	5 10 15	1 1 1	0.25 0.50 1.00	_ _ _	0.001 0.001 0.002	0.25 0.50 1.00	_ _ _	7.5 15.0 30.0	μА

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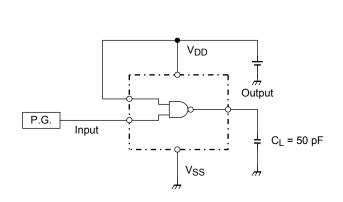
Note: All valid input combinations.

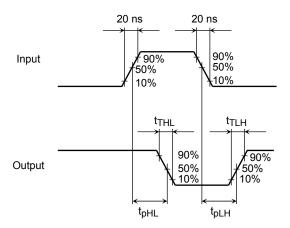
Dynamic Electrical Characteristics (Ta = 25 $^{\circ}$ C, V_{SS} = 0 V, C_L = 50 pF)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit	
Characteristics	Зуппоп		V _{DD} (V)	IVIIII	τyp.	IVIAX	Offic
			5	_	70	200	
Output transition time	t _{TLH}	_	10	_	35	100	ns
			15	_	30	80	
			5	_	70	200	
Output transition time	t _{THL}	_	10	_	35	100	ns
			15	_	30	80	
	t _{pLH}	_	5	_	65	200	ns
Propagation delay time			10	_	30	100	
			15	_	25	80	
Propagation delay time	t _{pHL}	_	5	_	65	200	
			10	_	30	100	ns
			15	_	25	80	
Input capacitance	C _{IN}	_		_	5	7.5	pF

Circuit and Waveform for Measurement of Dynamic Characteristics

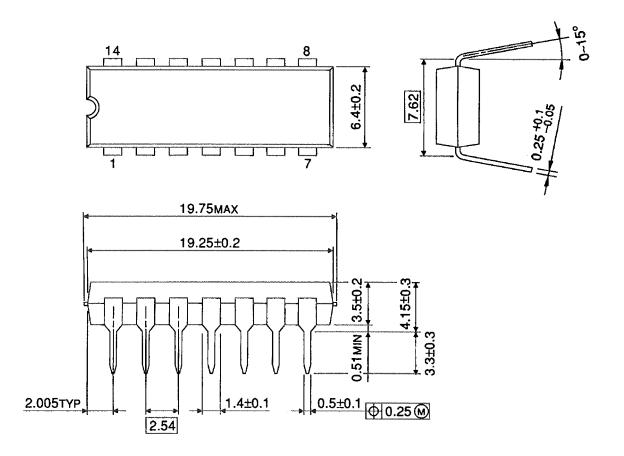
Circuit Waveform





Package Dimensions

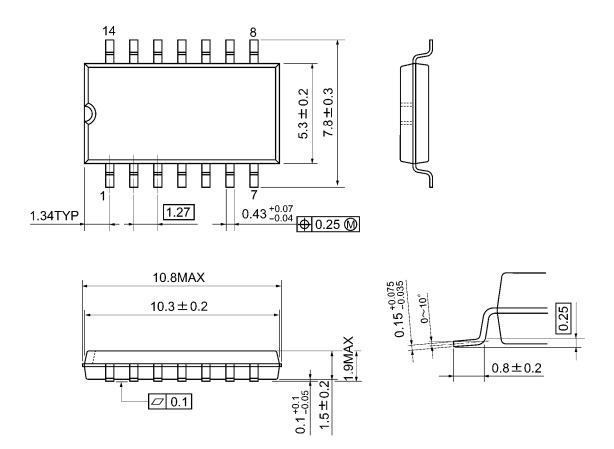
DIP14-P-300-2.54 Unit: mm



Weight: 0.96 g (typ.)

Package Dimensions

SOP14-P-300-1.27A Unit: mm



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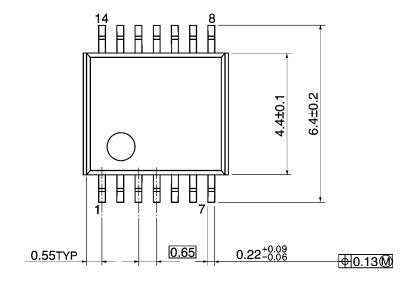
Weight: 0.18 g (typ.)

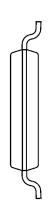
Package Dimensions

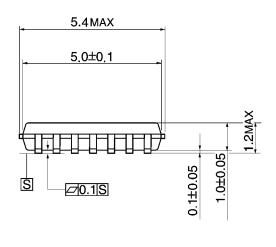
TOSHIBA

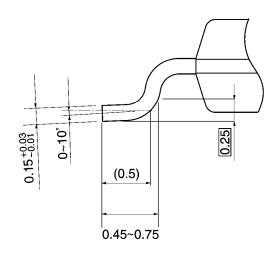
TSSOP14-P-0044-0.65A

Unit: mm









Weight: 0.06 g (typ.)

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